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Inverter with Schmitt-trigger Input



ADE-205-305C (Z)

4th. Edition Feb. 2003

Description

The HD74HCT1G14 is high speed CMOS schmitt-trigger inverter using silicon gate CMOS process. With CMOS low power dissipation, it provides high speed equivalent to LS-TTL series. The internal circuit of three stages construction with buffer provides wide noise margin and stable output.

Features

- The basic gate function is lined up as hitachi uni logic series.
- Supplied on emboss taping for high speed automatic mounting.
- TTL compatible input level.

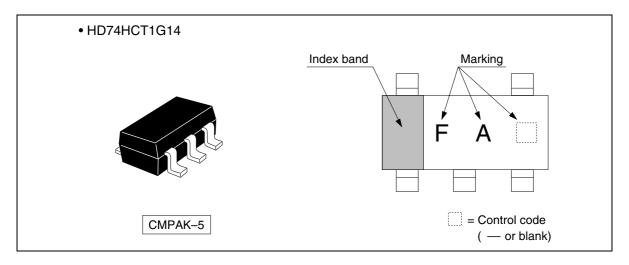
Supply voltage range: 4.5 to 5.5 V

Operating temperature range : -40 to +85°C

- $|I_{OH}| = I_{OL} = 2 \text{ mA (min)}$
- Ordering Information

Part Name	Package Type	Package Code	Package Abbreviation	Taping Abbreviation (Quantity)
HD74HCT1G14CME	CMPAK-5 pin	CMPAK-5V	СМ	E (3,000 pcs/reel)

Outline and Article Indication

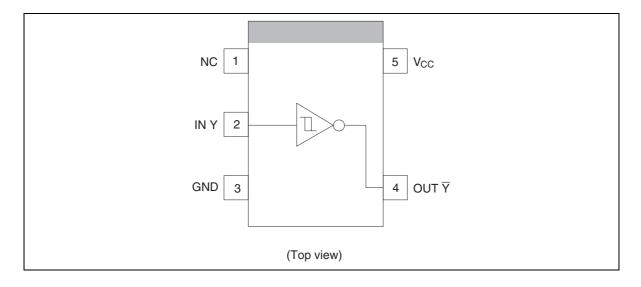


Function Table

Input A	Output \(\overline{\text{Y}} \)
Н	L
L	Н

H : High level L : Low level

Pin Arrangement



Absolute Maximum Ratings

Item	Symbol	Ratings	Unit	Test Conditions
Supply voltage range	V _{cc}	-0.5 to 7.0	V	
Input voltage range *1	V _i	-0.5 to $V_{cc} + 0.5$	V	
Output voltage range *1,2	V _o	-0.5 to $V_{cc} + 0.5$	V	Output : H or L
Input clamp current	I _{IK}	±20	mA	$V_{i} < 0 \text{ or } V_{i} > V_{cc}$
Output clamp current	I _{OK}	±20	mA	$V_{o} < 0 \text{ or } V_{o} > V_{cc}$
Continuous output current	Io	±25	mA	$V_o = 0$ to V_{cc}
Continuous current through V_{cc} or GND	I _{CC} or I _{GND}	±25	mA	
Maximum power dissipation at Ta = 25°C (in still air) ^{'3}	P _T	200	mW	
Storage temperature	Tstg	-65 to 150	°C	

Notes:

The absolute maximum ratings are values which must not individually be exceeded, and furthermore, no two of which may be realized at the same time.

- 1. The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
- 2. This value is limited to 5.5 V maximum.
- 3. The maximum package power dissipation was calculated using a junction temperature of 150°C.

Recommended Operating Conditions

Item	Symbol	Min	Max	Unit	Test Conditions
Supply voltage range	V _{cc}	4.5	5.5	V	
Input voltage range	V _i	0	5.5	V	
Output voltage range	V_{\circ}	0	V _{cc}	V	
Output current	I _{OL}	_	2	mA	$V_{cc} = 4.5 \text{ to } 5.5 \text{ V}$
	I _{OH}	_	-2	_	$V_{cc} = 4.5 \text{ to } 5.5 \text{ V}$
Operating temperature	Та	-40	85	°C	

Note: Unused or floating inputs must be held high or low.

Electrical Characteristics

Item	Symbol	\mathbf{V}_{cc}	T _a = 2	5°C		$T_a = -40 \text{ to } 85^{\circ}\text{C}$		Unit Test Con		ditions
		(V)	Min	Тур	Max	Min	Max	_		
Threshold	V _T ⁺	4.5	1.2	1.55	1.9	1.2	1.9	V		
voltage		5.5	1.4	1.80	2.1	1.4	2.1	_		
	V	4.5	0.5	0.87	1.2	0.5	1.2	٧		
		5.5	0.6	1.00	1.4	0.6	1.4	=		
	$\Delta V_{\scriptscriptstyle T}$	4.5	0.4	0.70	_	0.4	_	V		
		5.5	0.4	0.80		0.4	_	_		
Output voltage	V _{OH}	4.5	4.4	4.5		4.4	_	V	$V_{IN} = V_{IL}$	$I_{OH} = -20 \mu A$
		4.5	4.18	4.31	_	4.13	_	_		$I_{OH} = -2 \text{ mA}$
	V _{oL}	4.5	_	0.0	0.1	_	0.1	=	$V_{IN} = V_{IH}$	Ι _{οι} = 20 μΑ
		4.5	_	0.17	0.26	_	0.33	_		I _{oL} = 2 mA
Input current	I _{IN}	5.5	_	_	±0.1	_	±1.0	μΑ	$V_{IN} = V_{CC} C$	r GND
Operating current	I _{cc}	5.5	_	_	1.0	_	10.0	μΑ	$V_{IN} = V_{CC} C$	r GND
Quiescent supply current	I _{CCT}	5.5	_	_	2.0	_	2.9	mA	One input $V_{IN} = 2.4 \text{ V}$, other input V_{CC} or GND	

Switching Characteristics

Item	Symbol	Ta = 25	°C		Unit	Test Conditions		
		Min	Тур	Max				
Output rise / fall time	t _{tlh}	_	6	10	ns	Test circuit		
Propagation delay time	t _{PLH}		10	17	ns	Test circuit		
	t _{PHL}	_	10	17				

$$(C_L = 15 \text{ pF}, t_r = t_f = 6 \text{ ns}, V_{cc} = 5 \text{ V})$$

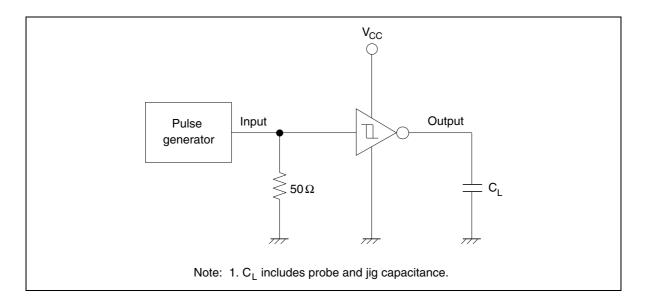
Item	Symbol		Ta =	= 25°C		Ta = −40 to 85°C		Unit	Test Conditions
		\mathbf{V}_{cc}	Min	Тур	Max	Min	Max	_	
Output rise / fall time	t _{tlh}	4.5	_	14	25	_	31	ns	Test circuit
Propagation delay time	t _{PLH}	4.5	_	16.4	27	_	31	ns	Test circuit
	t _{PHL}	4.5	_	16.4	27	_	31	_	
Input capacitance	C _{IN}	_	_	2.5	5	_	5	pF	
Equivalent capacitance	C _{PD}	_	_	10	_	_	_	pF	

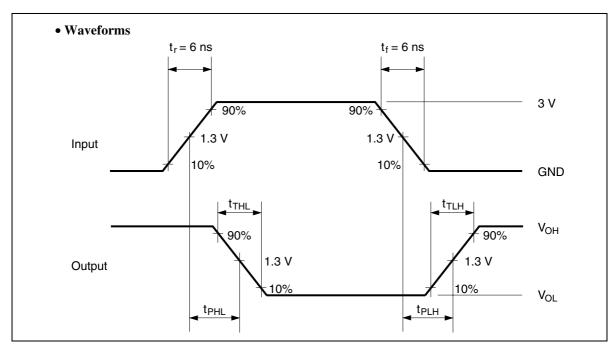
$$(C_L = 50 \text{ pF}, t_r = t_r = 6 \text{ ns})$$

Note: C_{PD} is equivalent capacitance inside of the IC calculated from the operating current without load (see test circuit). The average operating current without load is calculated according to the expression below.

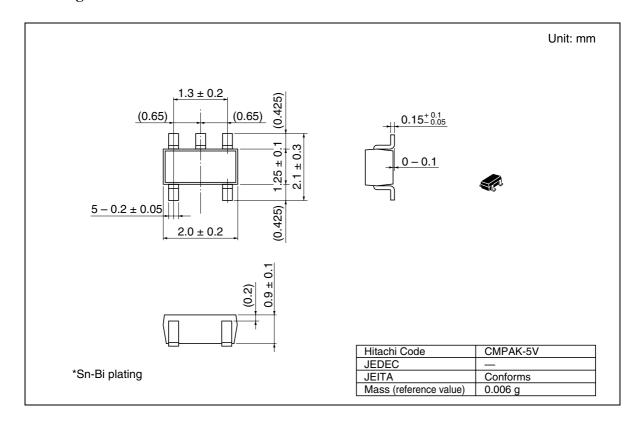
$$I_{cc}$$
 (opr) = $C_{pd} \cdot V_{cc} \cdot f_{iN} + I_{cc}$

Test Circuit





Package Dimensions



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